

# **Datasheet**

# **Gas Discharge Tubes (GDT)**

Series / Models	SMD2921-200N
Product Code	10.12.10.2000
Version	A0
Date	2025-01-02
File Number	SP-GDT-246





## SMD2921-200N

### 修订历史记录

版本	日期	制/修订页次	制/修订内容	制/修订者
A0	2025-01-02	1	新发行	吴霞

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#### SMD2921-200N

### **Description**

Gas discharge tubes (GDT) use noble gasses enclosed in ceramic tubes to provide an alternate circuit path for voltage spikes. The ceramic envelope and with nickel connectors allow for high loads. SMD2921 Gas Discharge Tubes (GDT) has a surge rating of 1kA, 8/20µs.Offered in a Squared Surface Mount package, which helps to make pick and place on PCB process easier.

This GDT series is perfectly suited for broadband equipment applications. The GDT's low off-state capacitance is compatible with high bandwidth applications and this capacitance loading value does not vary if the voltage across the GDT changes.

SMD2921 Gas Discharge Tube (GDT) is specifically designed for protection of electrical, multimedia, and communication equipment against over voltage transients in surface mount assembly applications.



## **Electrical symbol**



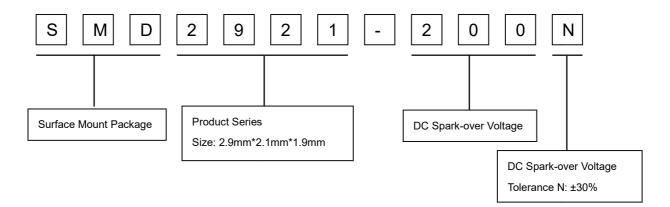
#### **Features**

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 1KA
- I Surface Mount package
- I Ultra Low capacitance(<0.5pF) and insertion loss
- I Size: 2.9mm\*2.1mm\*1.9mm

### **Applications**

- I Communication equipment
- I CATV equipment
- I Test equipment
- I Data lines
- I Power supplies
- I Telecom SLIC protection
- I Broadband equipment
- I ADSL equipment, including ADSL2+
- I XDSL equipment
- Satellite and CATV equipment
- I General telecom equipment

#### **Part Number Code**





#### SMD2921-200N

Electrical Characteristics				
DC Spark-over Voltage 1) 2)	at 100V/S		200±30%	V
Impulse Spark-over Voltage	at 100V/µS		<600	V
	at 1KV/μS		<700	V
Service life				
Impulse Discharge Current	8/20µS	±5 times	1	KA
Impulse Withstanding Voltage Capacity	10/700 $\mu$ S, 40 $\Omega$	±5 times	6	KV
Impulse Life	10/1000µS	100 times	10	А
Insulation Resistance	at DC 100V		>1	GΩ
Capacitance	at 1MHz		<0.5	pF
Glow Voltage	at 10mA		~60	V
Arc Voltage	at 1A		~10	V
Glow to Arc transition current			<0.2	А
Weight			~0.082	g
Operation temperature			-40~+125	°C
Recommended storage 3)				
- Temperature			+5~+35°C	
- Humidity			45~+80%	
- Period			≤ 2 years	
Climatic category (IEC60068-1)			40/125/21	
Marking			Without	
Surface treatment			Matte-tin plated	
Moisture sensitivity level 4)			1	

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Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T18802.311, GB/T 9043.

 $<sup>^{\</sup>rm 1)}\,$  At delivery AQL 0.65 level II, DIN ISO 2859.

<sup>2)</sup> In ionized mode.

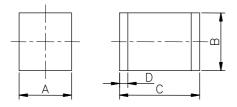
<sup>&</sup>lt;sup>3)</sup> Specified in terms of corrosion against tin plating.

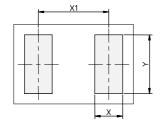
<sup>4)</sup> Tests according to JEDEC J-STD-020.



#### SMD2921-200N

# **Dimensions(unit: mm/inch)**



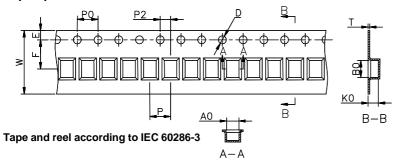


Recommended Soldering Pad Layout

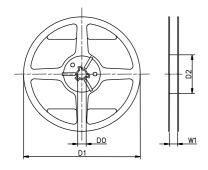
Symbol	Millimeters	Inches
Α	1.9±0.2	0.075±0.008
В	2.1±0.2	0.083±0.008
С	2.9±0.3	0.114±0.012
D	0.3±0.1	0.012±0.004
Х	0.7	0.028
<b>X</b> 1	2.9	0.114
Y	2.3	0.091

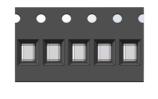
# **Packaging Information**

#### **Tape Specifications**



#### **Reel Specifications**







	T	T
Symbol	Millimeters	Inches
w	12±0.3	0.472±0.012
Α0	2.4±0.1	0.094±0.004
В0	3.2±0.1	0.126±0.004
K0	2.0±0.1	0.079±0.004
Р	4.0±0.1	0.157±0.004
F	5.5±0.1	0.217±0.004
E	1.75±0.1	0.069±0.004
D	1.5+0.1/-0.0	0.059+0.004/-0.0
P0	4±0.1	0.157±0.004
P2	2±0.1	0.079±0.004
Т	0.3±0.05	0.012±0.002
D0	13.3±0.15	0.524±0.006
D1	178±2	7.007±0.079
D2	60+1/-2	2.362+0.039/-0.07
W1	12.5±0.4	0.492±0.016

#### **Packaging Quantity:**

2,000 PCS per reel (7")

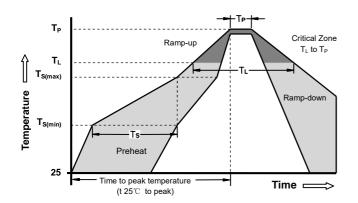
4 reels per inner box

8,000 PCS per inner box



#### SMD2921-200N

# **Soldering Parameters - Reflow Soldering (Surface Mount Devices)**



Reflow Condition		Pb - Free assembly	
Preheat	-Temperature Min (T <sub>s(min)</sub> )	150°C	
	-Temperature Max (T <sub>s(max)</sub> )	200°C	
	- Time (min to max) (t <sub>s</sub> )	60 -180 Seconds	
Average ramp up rate ( Liquids Temp T <sub>L</sub> ) to peak		3°C/second max	
T <sub>S(max)</sub> to TL -	Ramp-up Rate	5°C/second max	
Reflow	- Temperature (T <sub>L</sub> ) (Liquids)	217°C	
	- Time (min to max) (t <sub>s</sub> )	60 -150 Seconds	
Peak Temperature (T <sub>P</sub> )		260 +0/-5°C	
Time within 5°C of actual peak Temperature (t <sub>p</sub> )		10 - 30 Seconds	

## **Terms and definitions**

NO.	Item	Definitions	
	Gas discharge tube(GDT)	A gap, or several gaps, in an enclosed discharge medium, other than air at atmospheric pressure,	
1		designed to protect apparatus or personnel, or both, from high transient voltages. Also referred to as	
		"gas tube surge arrester".	
2	DC Spark-over Voltage	The voltage at which the gas discharge tube sparks over with slowly increasing d.c. voltage.	
3	Impulse Spark-over Voltage	The highest voltage which appears across the terminals of a gas discharge tube in the period between	
3		the application of an impulse of given wave-shape and the time when current begins to flow.	
5	Arc voltage	Voltage drop across the GDT during arc current flow.	
6	Glow voltage	Peak value of voltage drop across the GDT when a glow current is flowing.	
	Impulse discharge		
7	current 8/20µs	Current impulse with a nominal virtual front time of 8 μs and a nominal time to half-value of 20 μs.	
	Alternating	The rms value of an approximately sinusoidal alternating current passing through the gas discharge	
8	Discharge Current	tube.	
	Insulation	Insulation resistance shall be measured from each terminal to every other terminal of the GDT. The test	
9	Resistance	is performed with DC50V when normal spark-over Voltage 70~150V, others with DC100V.	
10	Capacitance	The capacitance shall be measured once at 1 MHz between all terminals unless otherwise specified.	

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#### SMD2921-200N

#### **Cautions**

- I Do not operate gas discharge tubes in power supply networks, whose maximum operating voltage exceeds the minimum spark-over voltage of the gas discharge tubes.
- I Gas discharge tubes may become hot in the event of longer periods of current stress (burn risk). In the event of overload the connectors may fail or the component may be destroyed.
- I Gas discharge tubes must be handled with care and must not be dropped.
- I Do not continue to use damaged gas discharge tubes.
- I The shown SMD pad dimensions represent a safe way to mount the arrester and are a recommendation of the manufacturer.

  During the reflow process it must be assured that no solder material reduces the insulation distance between the pads below the arrester.
- I SMD gas discharge tubes should be soldered within 24 month after shipment.
- I The electrical characteristics described in this datasheet are only typical characteristics, and all of these characteristics have been confirmed through testing and inspection. If the customer's usage requirements are different from this or have special requirements, please contact Ruilongyuan Electronics Co., Ltd. If protection failure or circuit damage occurs as a result, our company is not responsible for it.
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